



OrmoPrime20 Advanced **adhesion promoter** for Hybrid Polymers

Improved features

- Additional deposition methods possible
- Improved climate stability
- Lower film thickness
- Lower processing temperature required

Comparison of OrmoPrime20 with adhesion promoter OrmoPrime08*

	OrmoPrime20	OrmoPrime08
Adhesion performance (on Si and glass)	High	High
Deposition method	Spin coating, vapor deposition, dip coating	Spin coating
Climate stability (TelCordia test condi- tions)	High	Moderate
Film thickness	< 20 nm	130 nm
Processing temperature	80 °C	150 °C

*OrmoPrime08 still available on request

micro resist technology GmbH
Berlin - Germany

www.microresist.com